

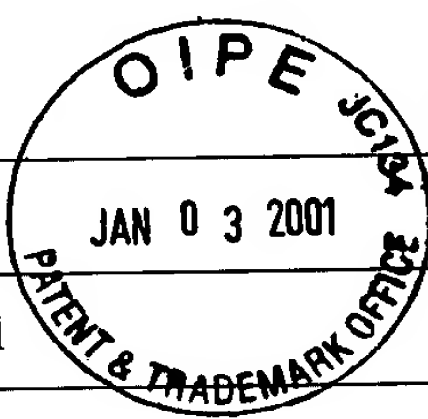
INFORMATION DISCLOSURE CITATION PTO-1449 JUN 20 2000 PATENT & TRADEMARK OFFICE			ATTY. DOCKET NO. 23587-702		SERIAL NO. 09/437,882	
			APPLICANT Kosowsky			
			FILING DATE November 10, 1999		GROUP 2811	
U.S. PATENT DOCUMENTS						
EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
IBP	3,685,026	08/15/1972	Wakabayashi, et al.	340	173 R	08/20/1970
IBP	3,808,576	04/30/1974	Castonguay, et al.	338	309	07/21/1972
IBP	3,977,957	08/31/1976	Kosowsky, et al.	204	224 R	09/04/1974
IBP	4,405,432	09/20/1983	Kosowsky	204	206	10/22/1982
IBP	4,642,160	02/10/1987	Burgess	156	630	08/12/1985
IBP	4,726,991	02/23/1988	Hyatt, et al.	428	329	07/10/1986
IBP	4,799,128	01/17/1989	Chen	361	414	04/10/1987
IBP	4,888,574	12/19/1989	Rice, et al.	338	309	03/28/1988
IBP	4,892,776	01/09/1990	Rice	428	209	09/02/1987
IBP	4,928,199	05/22/1990	Diaz, et al.	361	56	09/11/1989
IBP	4,935,584	06/19/1990	Boggs	174	262	05/24/1988
IBP	4,977,357	12/11/1990	Shrier	338	21	01/11/1988
IBP	5,068,634	11/26/1991	Shrier	338	21	08/08/1989
IBP	5,092,032	03/03/1992	Murakami	29	830	05/15/1991
IBP	5,095,626	03/17/1992	Kitamura, et al.	29	827	08/10/1989
IBP	5,099,380	03/24/1992	Childers, et al.	361	56	04/19/1990
IBP	5,142,263	08/25/1992	Childers, et al.	338	21	02/13/1991
IBP	5,148,355	09/15/1992	Lowe, et al.	361	410	10/22/1990
IBP	5,189,387	02/23/1993	Childers, et al.	338	20	07/11/1991
IBP	5,246,388	09/21/1993	Collins, et al.	439	620	06/30/1992
IBP	5,248,517	09/28/1993	Shrier, et al.	427	58	11/15/1991
IBP	5,252,195	10/12/1993	Kobayashi, et al.	205	126	10/28/1992
IBP	5,282,312	02/01/1994	DiStefano, et al.	29	830	12/31/1991
IBP	5,295,297	03/22/1994	Kitamura, et al.	29	827	07/20/1992
IBP	5,300,208	04/05/1994	Angelopoulos, et al.	205	50	08/14/1989
EXAMINER I. B. PATEL			DATE CONSIDERED 9/26/01			

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INFORMATION DISCLOSURE CITATION PTO-1419			ATTY. DOCKET NO. 23587-702		SERIAL NO. 09/437,882		
			APPLICANT Kosowsky				
			FILING DATE November 10, 1999		GROUP 2811		
U.S. PATENT DOCUMENTS							
EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE	
IBP	5,317,801	06/07/1994	Tanaka, et al.	29	830	01/29/1993	
IBP	5,347,258	09/13/1994	Howard, et al.	338	333	04/07/1993	
IBP	5,367,764	11/29/1994	DiStefano, et al.	29	830	12/31/1991	
IBP	5,404,637	04/11/1995	Kawakami	29	843	04/30/1993	
IBP	5,481,795	01/09/1996	Hatakeyama, et al.	29	852	06/10/1994	
IBP	5,487,218	01/30/1996	Bhatt, et al.	29	852	11/21/1994	
IBP	5,502,889	04/02/1996	Casson, et al.	29	830	01/08/1993	
IBP	5,654,564	08/05/1997	Mohsen	257	209	01/31/1996	
IBP	5,708,298	01/13/1998	Masayuki, et al.	257	723	12/10/1996	
IBP	5,734,188	03/31/1998	Murata, et al.	257	401	07/01/1996	
IBP	5,744,759	04/28/1998	Ameen, et al.	174	260	05/29/1996	
IBP	5,807,509	09/15/1998	Shrier, et al.	252	512	04/21/1997	
IBP	5,808,351	09/15/1998	Nathan, et al.	257	528	10/07/1994	
IBP	5,848,467	12/15/1998	Khandros, et al.	29	841	05/13/1997	
IBP	5,865,934	02/02/1999	Yamamoto, et al.	156	295	07/29/1997	
IBP	5,906,042	05/25/1999	Lan, et al.	29	852	10/04/1995	
IBP	5,910,685	06/08/1999	Watanabe, et al.	257	777	12/03/1997	
IBP	5,956,612	09/21/1999	Elliott, et al.	438	637	08/09/1996	
FOREIGN PATENT DOCUMENTS							
EXAMINER'S INITIALS	PATENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
IBP	WO 96/02944	02/01/1996	PCT	H01L	23/525	<input type="checkbox"/>	<input type="checkbox"/>
IBP	WO 96/02924	02/01/1996	PCT	H01C	7/10	<input type="checkbox"/>	<input type="checkbox"/>
IBP	WO 97/26665	07/24/1997	PCT	H01C	7/10	<input type="checkbox"/>	<input type="checkbox"/>
EXAMINER <i>IBP</i>			DATE CONSIDERED <i>9/26/01</i>				

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INFORMATION DISCLOSURE CITATION PTO-1449		ATTY. DOCKET NO. 23587-702		SERIAL NO. 09/437,882	
		APPLICANT Lex Kosowsky			
		FILING DATE Nov. 10, 1999		GROUP 2811	



U.S. PATENT DOCUMENTS						
EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
IB Patel	3,347,724	10-17-67	Schneble, Jr. et al.	156	151	8-19-64
IB Patel	4,113,899	9-12-78	Henry et al.	427	290	5-23-77

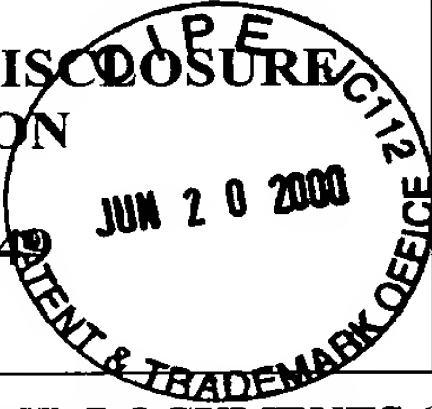
FOREIGN PATENT DOCUMENTS							
EXAMINER'S INITIALS	PATENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
IB Patel	WO 96/02922	01/02/96	PCT	H01C		<input type="checkbox"/>	<input type="checkbox"/>
IB Patel	CH 663 491 A5	15/12/87	Switzerland	H01L	23/14	<input type="checkbox"/>	<input checked="" type="checkbox"/>
IB Patel	DE3040784 A1	06/05/82	Germany	C23C	3/02	<input type="checkbox"/>	<input checked="" type="checkbox"/>
						<input type="checkbox"/>	<input type="checkbox"/>
						<input type="checkbox"/>	<input type="checkbox"/>

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)	
IB Patel	Susumu, T., "Laminated Sheet and Manufacture of Electric Wiring Circuit Using the Same", Patent Abstracts of Japan, Vol. 013, No. 243, 7 June 1989 (JP01045191, 17 Feb. 1989).

EXAMINER I. B. PATEL	DATE CONSIDERED 9/26/01
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		APPLICANT Kosowsky	
		FILING DATE November 10, 1999	GROUP 2811
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)			
IBP	Reimann; "Method for Forming a High Density Printed Wiring Board"; May 27, 1986; Pat. No. 4,591,411 156/634; abstract		
IBP	Bruckner, et al.; "Two-layer or Multilayer Printed Circuit Board"; January 3, 1995; Pat. No. 5,378,858; 174/255; abstract.		
IBP	Felcman, et al.; "Extended Card Edge Connector and Socket"; April 4, 1995; Pat. No. 5,403,208; 439/633; abstract.		
IBP	Yoshida, et al.; "Process for Producing Printed Wiring Board"; March 26, 1996; Pat. No. 5,501,350; 216/20; abstract.		
IBP	Alpaugh, et al.; "Method of Making Printed Circuit Board"; November 11, 1997; Pat. No. 5,685,070; 29/840; abstract.		
IBP	Kobayashi, et al.; "Method of Finishing a Printed Wiring Board with a Soft Etching Solution and a Preserving Treatment or a Solder-Leveling Treatment"; September 8, 1998; Pat. No. 5,802,714; 29/852; abstract.		
IBP	Ferry, et al.; "Method and Apparatus for forming Fine Patterns on Printed Circuit Board"; November 10, 1998; Pat. No. 5,834,160; 430/313; abstract.		
IBP	Yurchenco, et al.; "Processor Card Assembly Having a Cover with Flexible Locking Latches"; January 5, 1999; Pat. No. 5,856,910; 361/704; abstract.		
IBP	Khandros, et al.; "Method of Stacking Electronic Components"; July 27, 1999; Pat. No. 5,926,951; 29/843; abstract.		
EXAMINER	I. B. PATEL		DATE CONSIDERED 9/26/01.

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